

FMM5822X

K-Band Power Amplifier MMIC

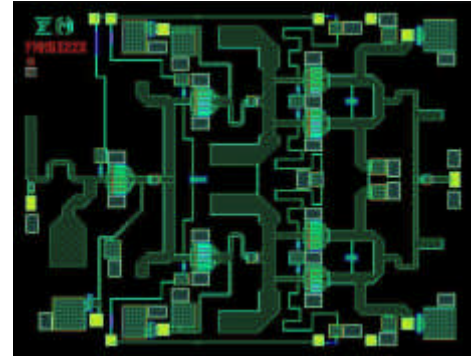
FEATURES

- High Output Power; P1dB = 32.5 dBm (Typ.)
- High Linear Gain; GL = 22 dB(Typ.)
- Frequency Band ; 17.5 - 20.0 GHz
- High Linearity ; OIP3 = 41dBm
- Impedance Matched Zin/Zout = 50Ω

DESCRIPTION

The FMM5822X is a power amplifier MMIC that contains a three stage amplifier, internally matched, for standard communications band in 17.5 to 20.0GHz frequency range. This product is well suited for point-to-point radio applications.

Eudyna's stringent Quality Assurance Program assures the highest reliability and consistent performance.



ABSOLUTE MAXIMUM RATING

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	VDD		10	V
Gate-Source Voltage	VGG		-3	V
Input Power	Pin		25	dBm
Storage Temperature	Tstg		-55 to +125	

RECOMMENDED OPERATING CONDITIONS

Item	Symbol	Condition	Recommended	Unit
Drain-Source Voltage	VDD		7*	V
Input Power	Pin		15	dBm
Operating Backside Temperature	Top		-40 to +85	

* : FMM5822X/001 Recommended Drain-Source Voltage VDD = 8V

This Product should be hermetically packaged.

ELECTRICAL CHARACTERISTICS (Ambient Temperature Ta=25 °C)

Item	Symbol	Test Conditions	Limits			Unit
			Min.	Typ.	Max.	
Frequency Range	f	VDD=6.0V	17.5	-	20	GHz
Output Power at 1dB G.C.P.	P1dB	IDD(DC)=850mA typ.	30.5	32.5	-	dBm
Power Gain at 1dB G.C.P.	G1dB	Zs=Zl=50ohm	19	21	25	dB
Power Added Efficiency at 1dB G.C.P.	Nadd		-	30	-	%
Third Order Intermodulation	IM3*	*df=10MHz,Po=20.5dBm	-38	-41	-	dBc
Drain Current at 1dB G.C.P.	Iddrf	(S.C.L.)	-	1000	1500	mA
Input Return Loss at Pin=-20dBm	RLin		-	-8	-	dB
Output Return Loss at Pin=-20dBm	RLout		-	-12	-	dB

Note : RF parameter sample size 10ps. Criteria (accept/reject)=(0/1)

G.C.P. : Gain Compression Point

S.C.L. : Single Carrier Level

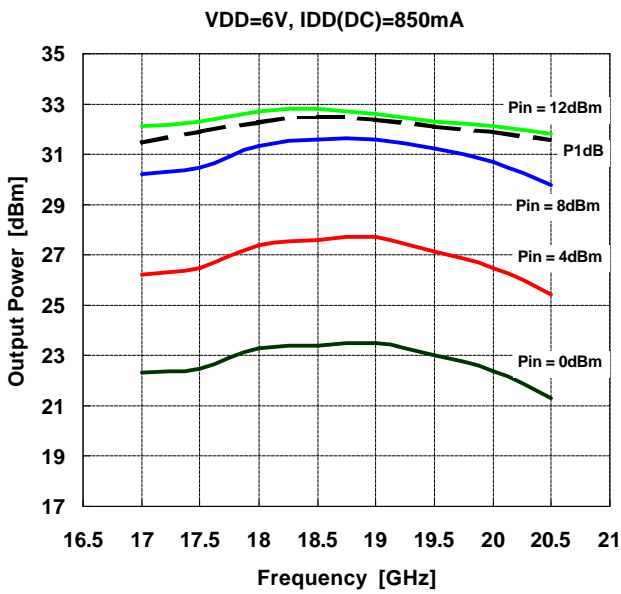
ESD	Class 0	~ 199V
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Note : Based on EIAJ ED-4701 C-111A(C=100pF, R=1.5k)

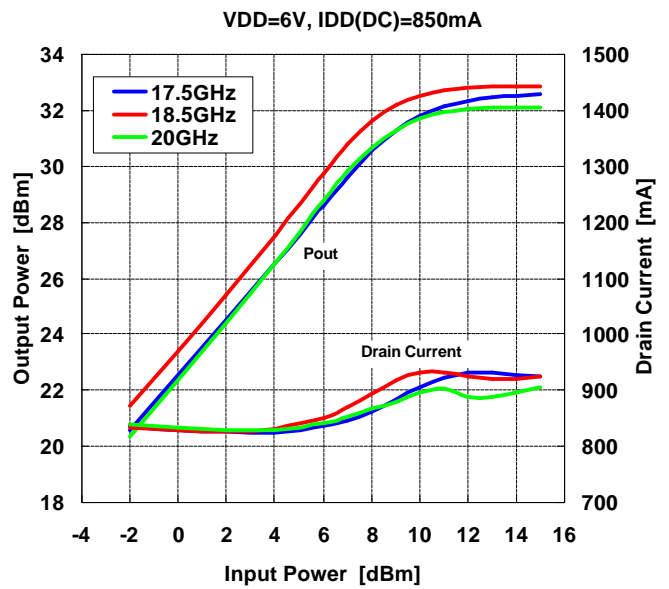
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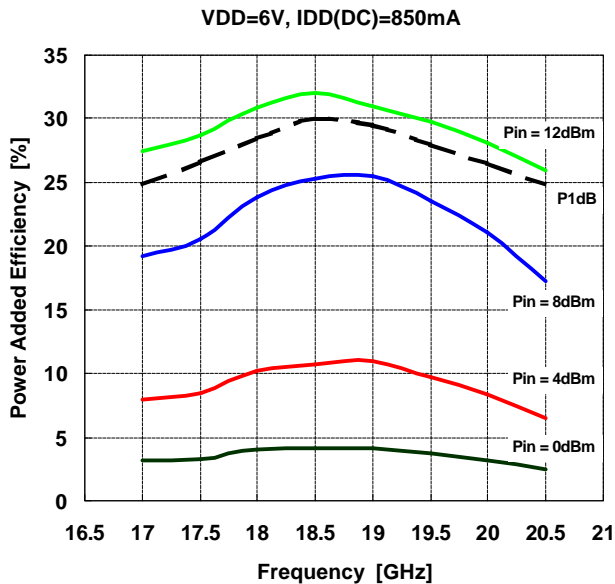
Output Power vs. Frequency



Output Power, Drain Current vs. Input Power



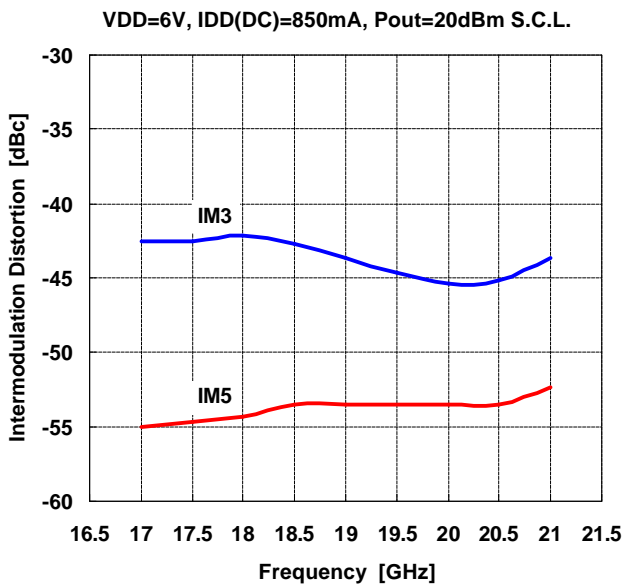
Power Added Efficiency vs. Frequency



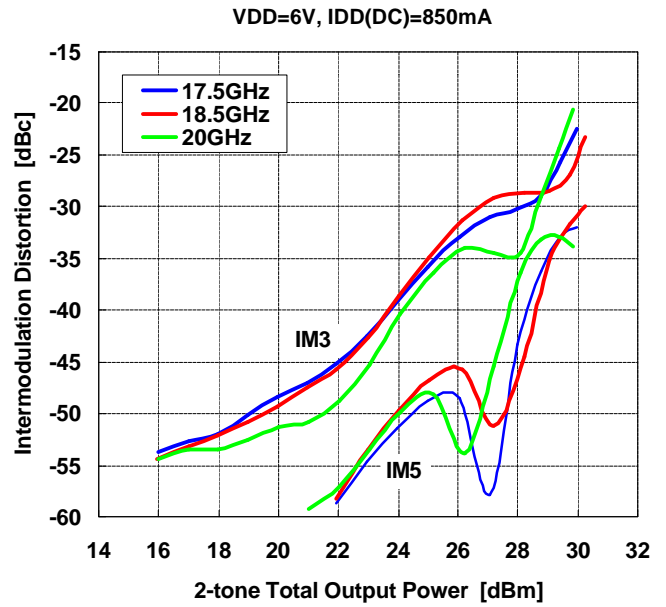
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IMD vs. Frequency



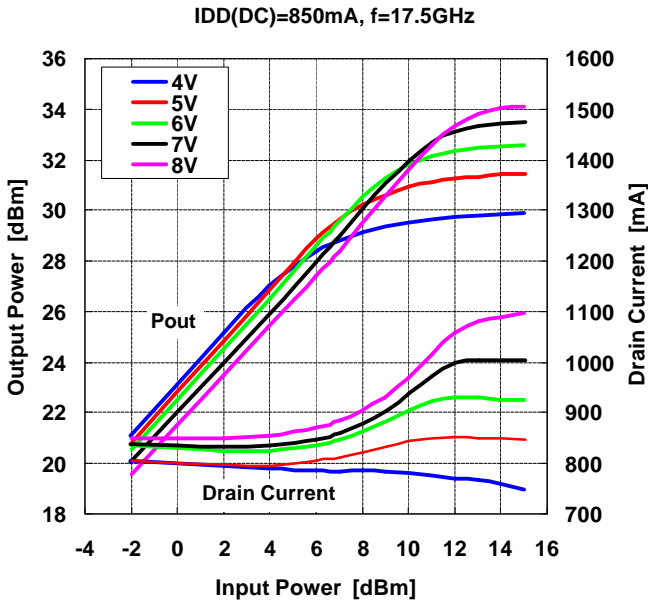
IMD vs. Output Power



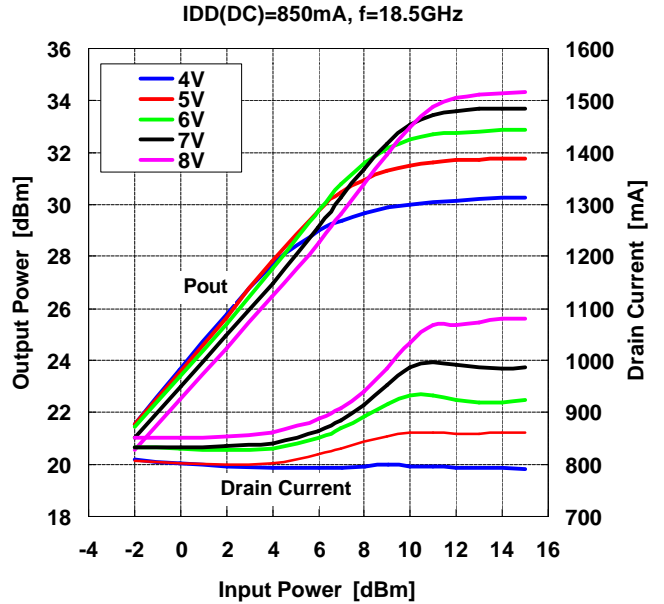
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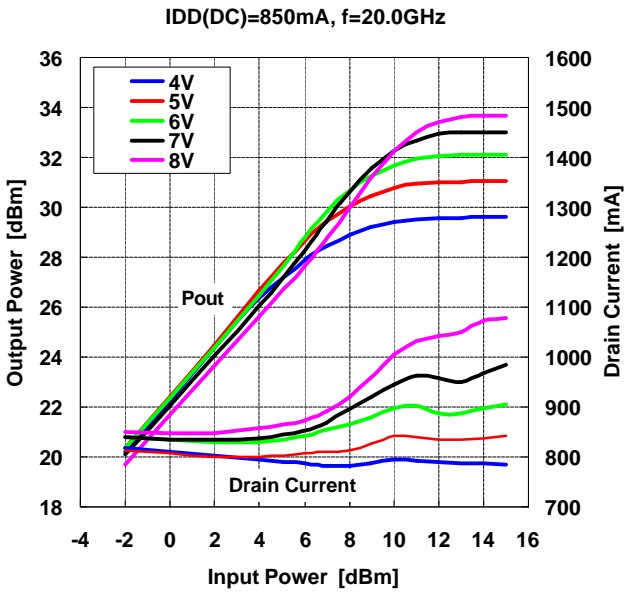
Output Power, Drain Current vs. Input Power by Drain Voltage



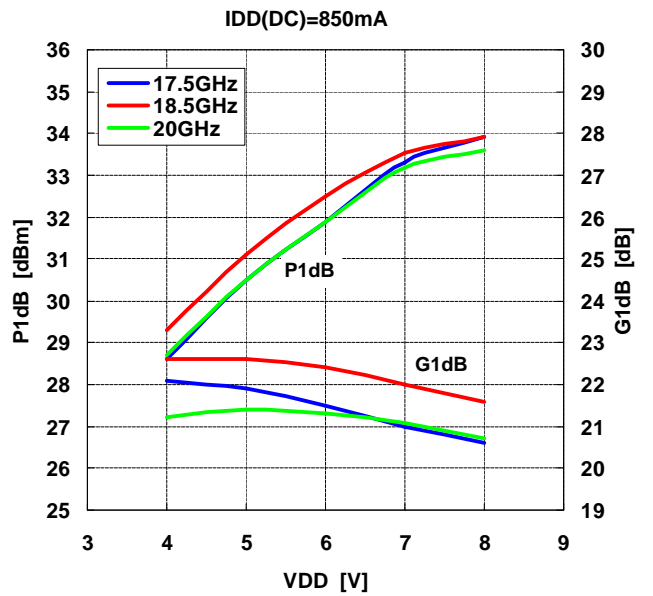
Output Power, Drain Current vs. Input Power by Drain Voltage



Output Power, Drain Current vs. Input Power by Drain Voltage



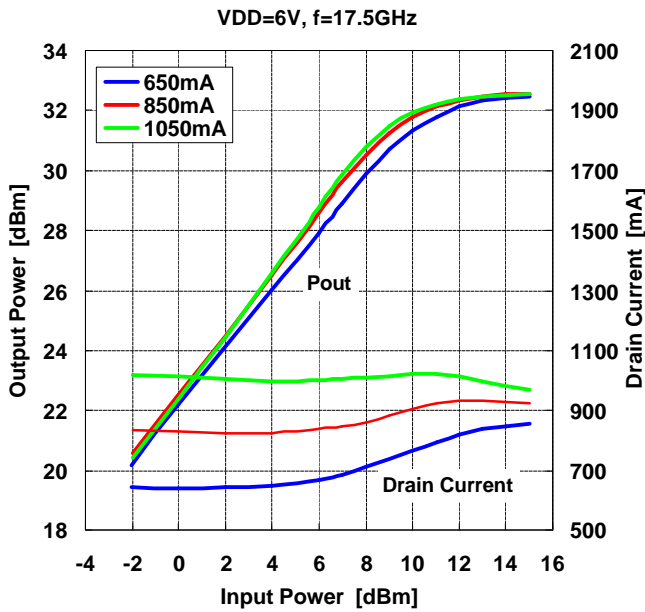
Output Power, Gain vs. Drain Voltage



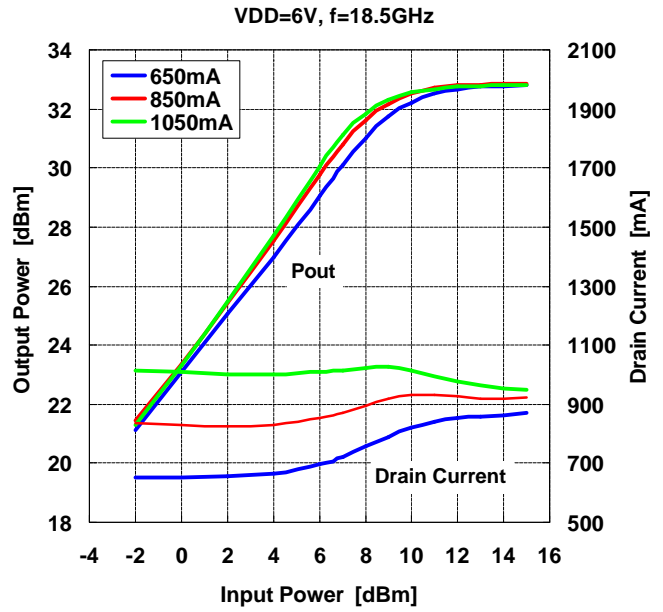
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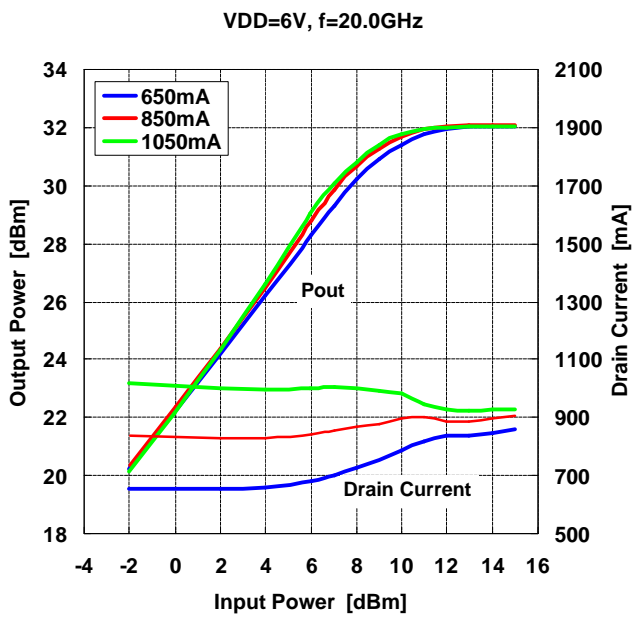
Output Power, Drain Current vs. Input Power by Drain Current



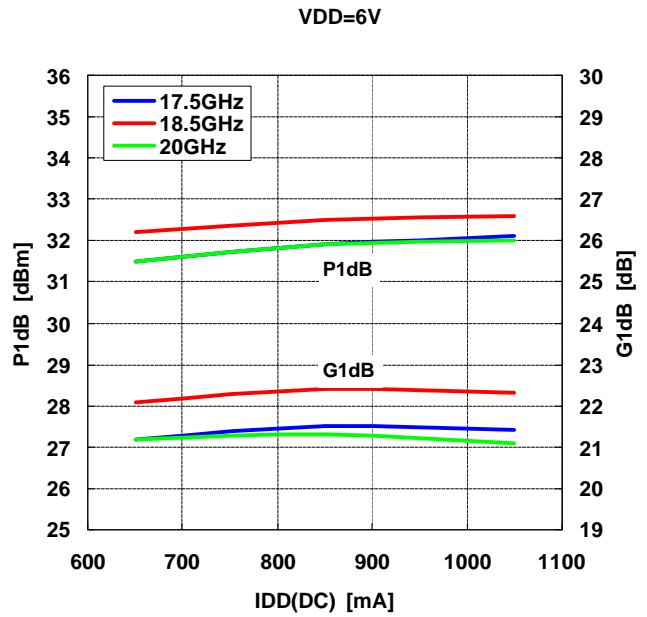
Output Power, Drain Current vs. Input Power by Drain Current



Output Power, Drain Current vs. Input Power by Drain Current



Output Power, Gain vs. Drain Current

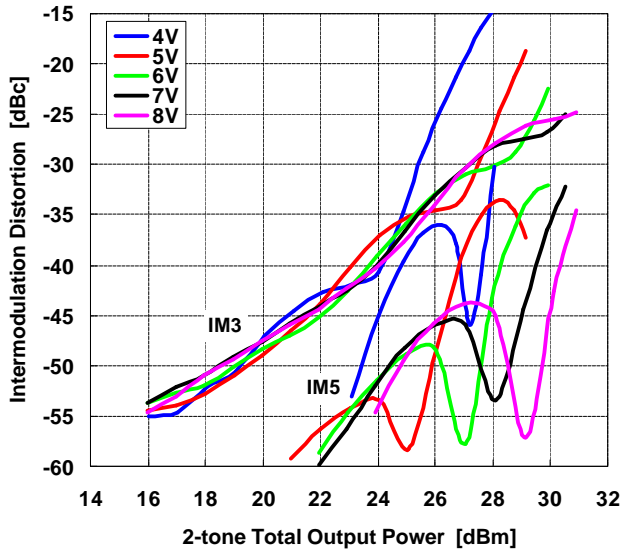


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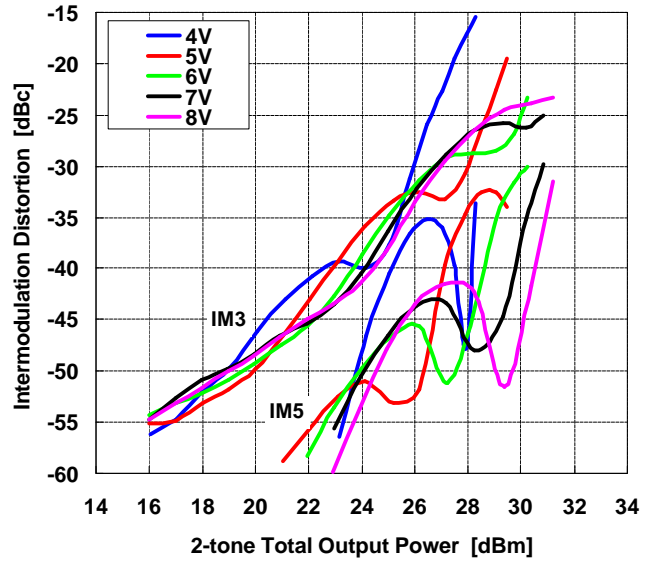
IMD vs. Output Power
by Drain Voltage

IDD(DC)=850mA, f=17.5GHz



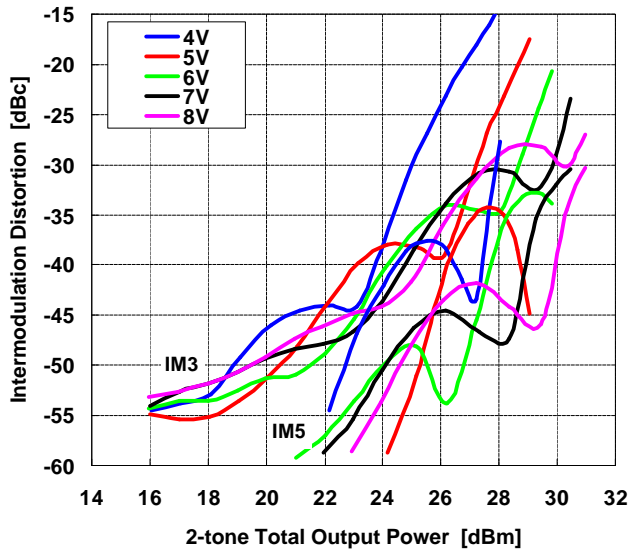
IMD vs. Output Power
by Drain Voltage

IDD(DC)=850mA, f=18.5GHz



IMD vs. Output Power
by Drain Voltage

IDD(DC)=850mA, f=20.0GHz

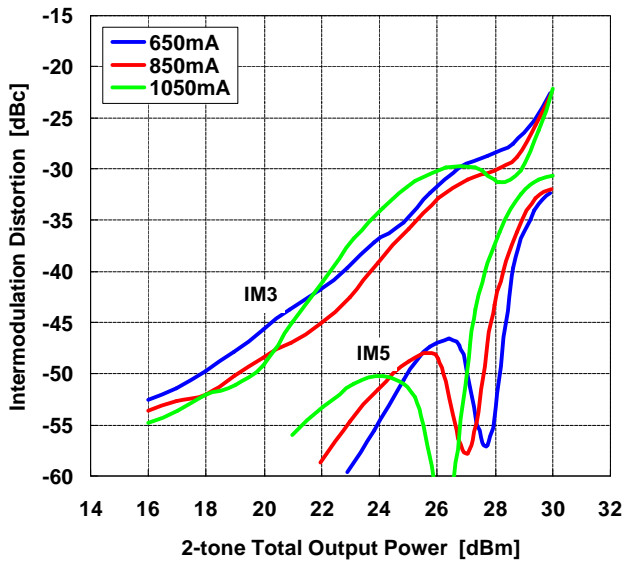


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K-Band Power Amplifier MMIC

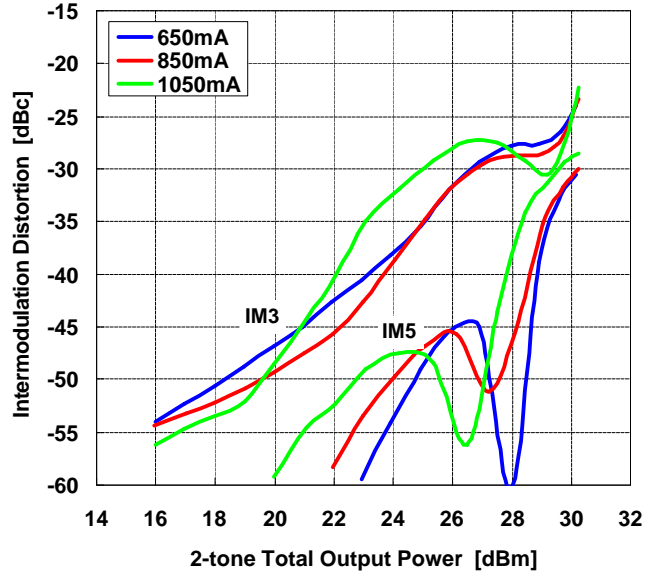
IMD vs. Output Power
by Drain Current

VDD=6V, f=17.5GHz



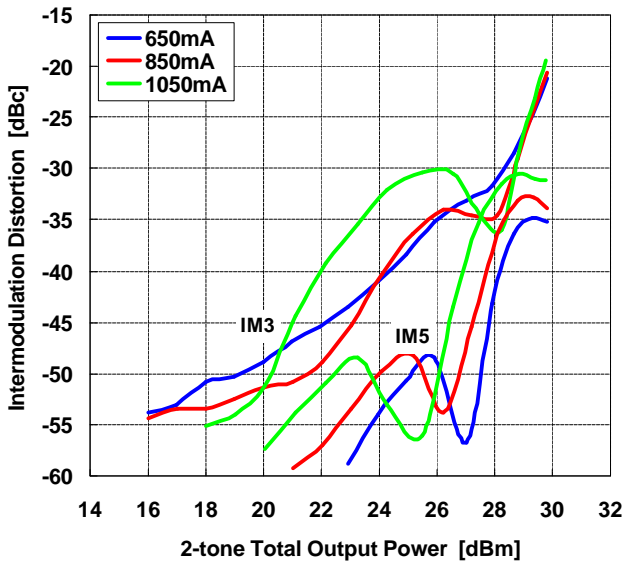
IMD vs. Output Power
by Drain Current

VDD=6V, f=18.5GHz



IMD vs. Output Power
by Drain Current

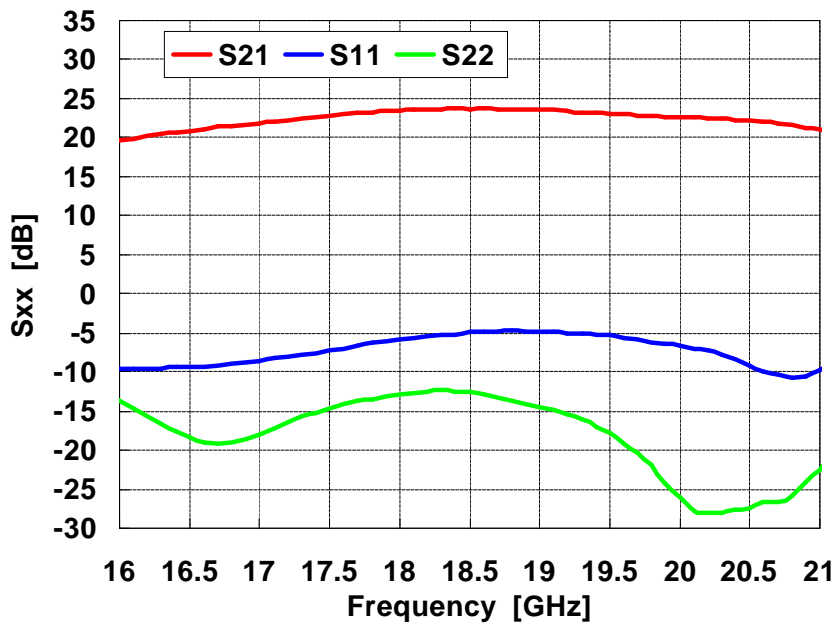
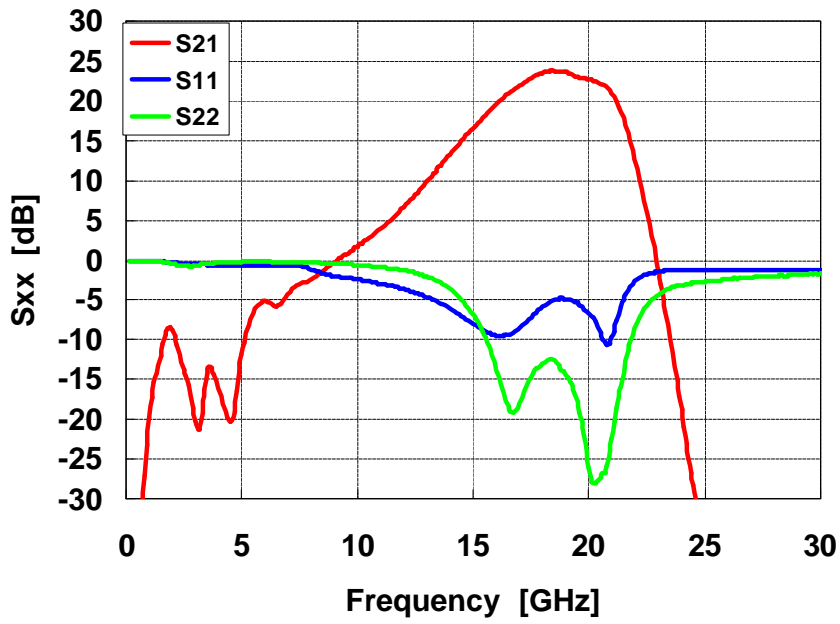
VDD=6V, f=20.0GHz



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S-PARAMETER



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K-Band Power Amplifier MMIC

S-PARAMETER

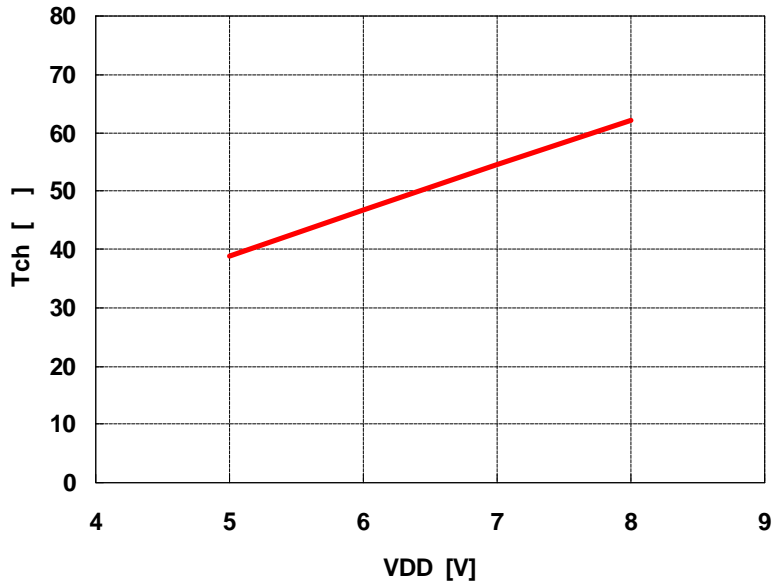
VDD=6V, IDD=850mA

Frequency [GHz]	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
1.0	0.98	-27.0	0.10	43.4	0.00	-106.0	0.99	-44.1
2.0	0.97	-52.2	0.36	-145.5	0.00	-128.4	0.94	-80.3
3.0	0.94	-73.4	0.10	145.9	0.00	-87.5	0.92	-102.7
4.0	0.93	-91.8	0.16	123.0	0.00	-108.9	0.96	-121.7
5.0	0.93	-108.1	0.26	163.1	0.00	-111.3	0.98	-137.4
6.0	0.93	-122.9	0.55	83.8	0.00	-95.4	0.98	-150.8
7.0	0.93	-137.6	0.61	45.3	0.00	-81.8	0.97	-162.1
8.0	0.87	-153.7	0.76	0.4	0.00	-62.2	0.96	-172.0
9.0	0.79	-163.6	0.97	-38.0	0.00	-80.7	0.95	177.9
10.0	0.75	-173.6	1.22	-78.6	0.00	-104.3	0.93	167.5
11.0	0.71	175.2	1.58	-117.2	0.00	-131.4	0.90	156.2
12.0	0.66	162.3	2.16	-157.4	0.00	173.8	0.86	142.7
13.0	0.59	147.3	3.11	158.4	0.00	-42.1	0.79	125.8
14.0	0.50	128.4	4.60	108.1	0.00	-25.2	0.66	103.2
15.0	0.40	103.9	6.75	51.6	0.00	-39.4	0.45	72.4
16.0	0.33	70.4	9.61	-11.8	0.00	-40.1	0.20	25.0
17.0	0.37	16.9	12.43	-82.7	0.01	-48.2	0.13	-93.4
17.1	0.39	11.1	12.66	-89.6	0.01	-47.9	0.14	-104.1
17.2	0.39	4.6	13.01	-97.0	0.01	-53.1	0.15	-112.5
17.3	0.41	-1.2	13.24	-104.4	0.01	-53.3	0.16	-119.7
17.4	0.42	-7.4	13.56	-111.8	0.01	-53.6	0.17	-126.9
17.5	0.43	-12.8	13.78	-119.8	0.01	-59.5	0.19	-132.7
17.6	0.45	-18.9	14.07	-127.1	0.01	-57.0	0.20	-140.4
17.7	0.46	-24.9	14.38	-135.3	0.00	-70.9	0.21	-146.6
17.8	0.48	-30.1	14.50	-143.1	0.01	-67.3	0.21	-153.6
17.9	0.49	-36.5	14.90	-151.0	0.01	-72.1	0.22	-159.3
18.0	0.51	-41.6	14.96	-159.6	0.01	-84.9	0.22	-164.7
18.1	0.52	-47.4	15.18	-167.5	0.01	-78.6	0.23	-170.8
18.2	0.53	-52.5	15.31	-176.4	0.01	-80.5	0.23	-176.3
18.3	0.55	-57.9	15.27	175.8	0.01	-77.5	0.24	178.5
18.4	0.55	-63.4	15.43	166.9	0.01	-83.1	0.24	172.8
18.5	0.57	-68.9	15.25	158.8	0.01	-97.7	0.23	166.8
18.6	0.57	-74.4	15.34	150.6	0.01	-97.8	0.23	160.6
18.7	0.57	-79.3	15.23	141.9	0.01	-101.9	0.22	154.6
18.8	0.58	-85.3	15.22	134.1	0.01	-112.6	0.21	151.1
18.9	0.57	-89.9	15.19	125.4	0.01	-110.9	0.20	144.4
19.0	0.57	-94.9	15.03	116.9	0.01	-114.1	0.19	138.4
19.1	0.57	-100.3	15.02	108.4	0.01	-127.0	0.18	132.5
19.2	0.56	-104.8	14.75	99.5	0.01	-121.8	0.17	126.5
19.3	0.56	-110.0	14.55	91.4	0.00	-141.5	0.16	119.3
19.4	0.54	-115.1	14.36	82.9	0.00	-148.2	0.14	114.1
19.5	0.54	-120.1	14.07	75.0	0.01	-138.9	0.13	109.6
19.6	0.52	-125.2	14.01	66.9	0.00	-158.6	0.11	100.4
19.7	0.51	-130.1	13.78	58.4	0.00	-174.6	0.10	92.9
19.8	0.49	-136.3	13.76	50.5	0.00	155.8	0.08	80.4
19.9	0.47	-141.0	13.64	41.4	0.00	133.3	0.06	70.4
20.0	0.46	-147.8	13.54	33.1	0.00	104.2	0.05	63.2
21.0	0.33	70.0	11.17	-70.5	0.01	-1.2	0.08	15.6
22.0	0.73	-36.9	4.27	174.8	0.01	-60.8	0.37	-24.4
23.0	0.85	-75.1	0.84	90.0	0.00	-81.5	0.61	-68.8
24.0	0.87	-94.6	0.11	45.9	0.00	49.0	0.70	-95.2
25.0	0.87	-107.0	0.02	88.6	0.01	-11.8	0.73	-111.2
26.0	0.87	-115.5	0.02	91.1	0.01	-41.2	0.76	-122.1
27.0	0.87	-122.5	0.02	57.6	0.01	-21.4	0.78	-130.6
28.0	0.86	-127.7	0.02	36.7	0.01	-1.4	0.79	-137.9
29.0	0.86	-131.8	0.02	0.2	0.02	-13.2	0.81	-143.8
30.0	0.87	-135.6	0.02	-20.5	0.02	-30.0	0.83	-149.6

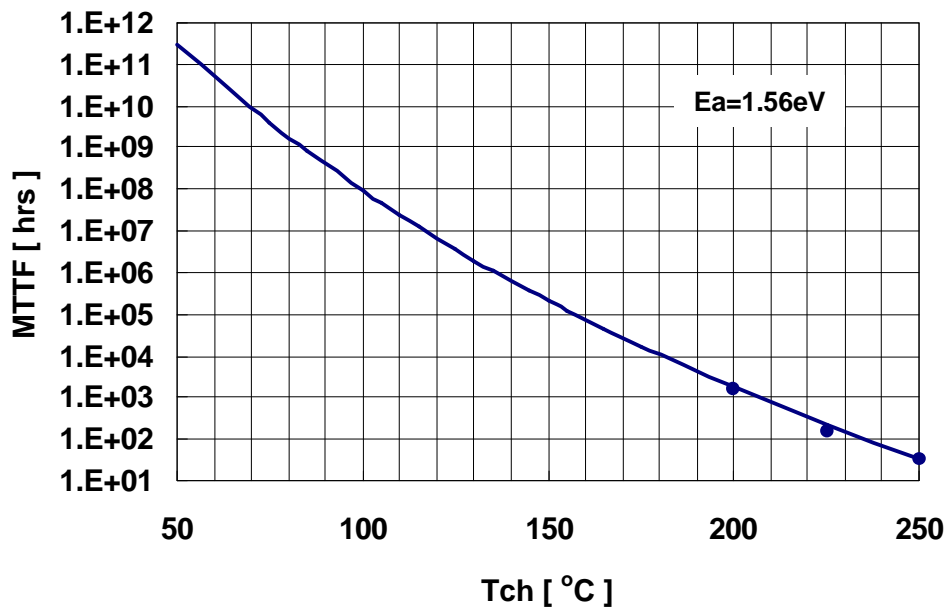
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Tch vs. Drain Voltage
(Reference)



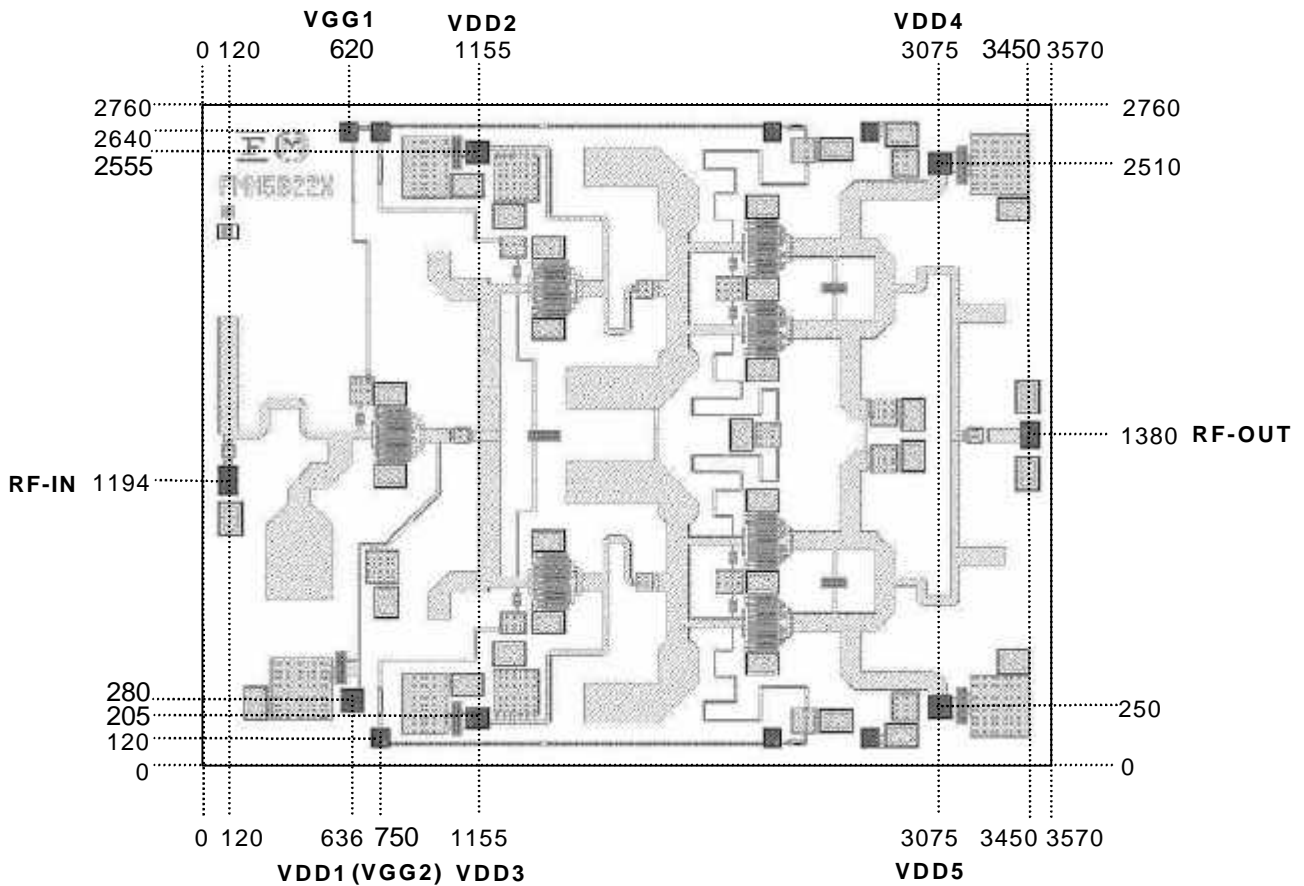
MTTF vs. Tch



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Chip Outline and Bonding Pad Locations (Dimension in Micro-Meters)



Chip Size : 3570 ± 30um x 2760 ± 30um
Chip Thickness : 70 ± 20um
Bonding Pad Size :
RF-Pad : 120um x 80um
VGG-Pad : 80um x 80um
VDD-Pad : 100um x 100um

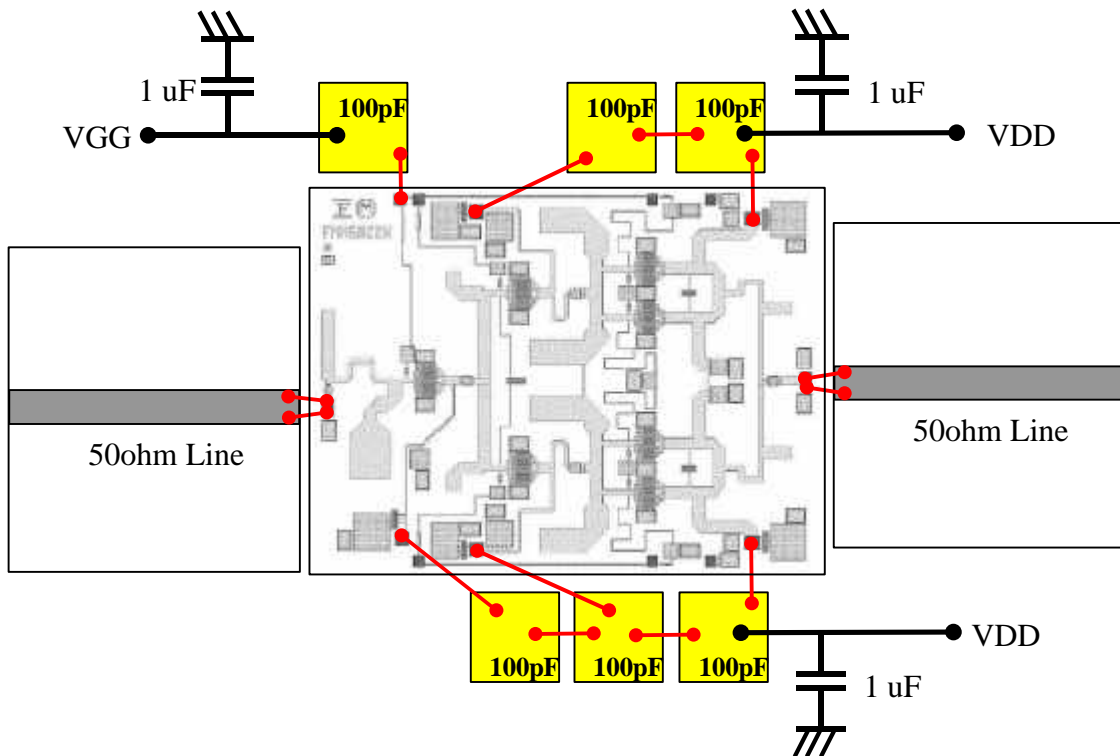
Note: Gate voltage is required from either or both bonding pad(VGG1 or/and VGG2).

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Assembly Diagrams

Recommended assembly



“Copper” is the recommended material for the package or carrier.

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DIE ATTACH

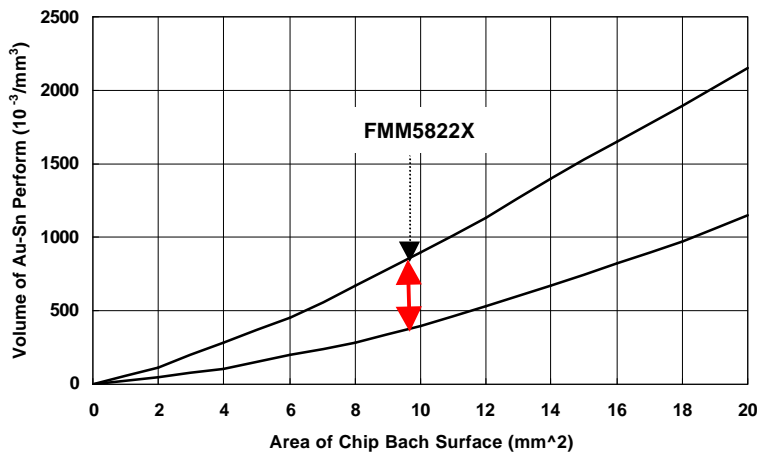
- 1) The die-attach station must have accurate temperature control and an inert forming gas should be used.
- 2) Chips should be kept at room temperature except during die-attach.
- 3) Place package or carrier on the heated stage.
- 4) Lightly grasp the chip edges by the longer side using tweezers.

Die attach conditions

Stage Temperature : 300 to 310 deg.C

Time : less than 15 seconds

AuSn Preform Volume : per next Figure



WIRE BONDING

The bonding equipment must be properly grounded. The following or equivalent equipment, tools, materials, and conditions are recommended.

- 1) Bonding Equipment and Bonding Tool.

Bonding Equipment : West Bond Model 7400 (Manual Bonder)

Bonding Tool : CCOD-1/16-S-437-60-F-2010-MP (Deweyl)

- 2) Bonding Wire

Material : Hard or Half hard gold

Diameter : 0.7 to 1.0 mil

- 3) Bonding Conditions

Method : Thermal Compression Bonding with Ultrasonic Power

Tool Force : $0.196 \text{ N} \pm 0.0196 \text{ N}$

Stage Temperature : $215 \text{ deg.C} \pm 5 \text{ deg.C}$

Tool Heater : None

Ultrasonic Power Transmitter : West Bond Model 1400

Duration : 150 mS/Bond

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For further information please contact :

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CAUTION

Eudyna Devices Inc. products contain **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

Do not put these products into the mouth.

Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.

Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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